PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
CHUAN WANG	05/07/2019	
LE CAI	05/01/2019	

RECEIVING PARTY DATA

Name:	BOARD OF TRUSTEES OF MICHIGAN STATE UNIVERSITY
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City:	EAST LANSING
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PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16195004	

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ATTORNEY DOCKET NUMBER:	32213/52603A US
NAME OF SUBMITTER:	PAUL B. STEPHENS
SIGNATURE:	/Paul B. Stephens/
DATE SIGNED:	05/21/2019

Total Attachments: 4

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PATENT 505486061 REEL: 049239 FRAME: 0689

ASSIGNMENT

As a below-named inventor, I hereby declare that:

My post office address is as stated below under my signature and I am named as an inventor of the inventions (herein INVENTIONS) as described in the patent application (herein APPLICATION) identified below.

Title: Fully-Printed Stretchable Thin-Film Transistors and Integrated Logic Circuits

Inventors: Chuan Wang and Le Cai

Serial Number: 16/195,004

Filing Date: November 19, 2018

In view of valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and further in view of my obligations respecting "University Inventions" as set forth in the current version of the MSU Faculty Handbook, I do hereby assign and transfer unto the BOARD OF TRUSTEES OF MICHIGAN STATE UNIVERSITY, 450 Administration Building, East Lansing, MI 48824-1046 (herein ASSIGNEE), my entire right, title and interest in and to the INVENTIONS, the APPLICATION and the right of priority thereto, and all related applications (including provisional applications, non-provisional regular applications, divisions, reissues, reexaminations, supplemental examinations, inter partes reviews, oppositions, post grant reviews, continuations, international patent applications, foreign patent applications, supplementary protection certificates, and extensions thereof, whether or not claiming priority to the APPLICATION) and all counterparts in other countries and any and all Letters Patent (and certificates of invention or similar certificates) (herein PATENTS) which may be granted based upon the INVENTIONS or the APPLICATION or related applications or counterparts in other countries, including the right to bring suit and to claim and retain all damages and/or seek other remedies for the past, present, or future infringement of any of the foregoing, the right to claim priority benefit to the APPLICATION or related applications, and the right to issue the PATENTS in the name of the ASSIGNEE, this assignment being applicable throughout the world; and I do hereby agree to assign and transfer unto ASSIGNEE, its successors or assigns, on like terms as set forth in this Assignment, my entire right, title and interest in and to any continuation-in-part applications related to the APPLICATION or to any other related applications related to the APPLICATION herein assigned (including non-provisional regular applications, divisions, reissues, reexaminations, supplementary examinations, inter partes reviews, oppositions, post grant reviews, continuations, international patent applications, foreign patent applications, supplementary protection certificates, and extensions thereof claiming priority to the APPLICATION).

I agree that I will communicate to ASSIGNEE or its designated representatives any material facts known to me respecting the INVENTIONS and/or the APPLICATION; testify in any legal proceedings respecting the INVENTIONS; and execute any and all papers deemed necessary by ASSIGNEE, its successors or assigns, to secure the rights herein assigned.

I hereby represent and warrant that (i) I have the right to make this assignment to the ASSIGNEE, (ii) I have not granted any rights inconsistent with the rights granted herein, and (iii) there are no outstanding encumbrances, liens, prior assignments, licenses or other obligations or restrictions on the rights, titles, and interest herein assigned.

PATENT REEL: 049239 FRAME: 0690 Atty, Docket No. 32213/52603A
Chuan Wang and Le Cai, "Fully-Printed Stretchable Thin-Film Transistors and Integrated Logic Circuits"

I authorize ASSIGNEE or its representatives to complete the Application Serial Number and Filing Date of the Application, once known, if that information is not specified above as of the date of my signature hereto.

On behalf of Assignee,	Richard Chylla
	Name
	Executive Director of MSU Technologies, on behalf of Board of Trustees of Michigan State University
	Title

Garature S/A/19
Date

FULL NAME OF INVENTOR	:	Chuan Wang		
Inventor's signature Residence Citizenship Post Office Address	: : : : : : : : : : : : : : : : : : : :	Haslett, Michigan 48840 US 6336 Lake Drive Haslett, Michigan 48840	_ Date: _	5/7/2019
Signed and witnessed in the pres	sence of:			
XMG HUANG (Typed or printed name of witnes	es)			
FULL NAME OF INVENTOR	:	Le Cai		
Inventor's signature Residence	:	Los Angeles, California 90024	_ Date: _	
Citizenship Post Office Address	:	US 1441 S Beverly Glen Blvd Los Angeles, California 90024		
Signed and witnessed in the pres	sence of:			

(Typed or printed name of witness)

FULL NAME OF INVENTOR	:	Chuan Wang		
Inventor's signature			_ Date: _	
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FULL NAME OF INVENTOR	:	Le Cai		
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Signed and witnessed in the pres	sence of:			
Lijun Wang				
Lijun Wang Lijun Wang	7			
(Typed or printed name of witnes	s)			

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PATENT REEL: 049239 FRAME: 0693

RECORDED: 05/21/2019